

# LNPTM STAT-LOYTM COMPOUND N30009

PCA-FR

REGION AMERICAS

## DESCRIPTION

LNP STAT-LOY N30009 compound is based on Polycarbonate/Acrylonitrile Butadiene Styrene (PC/ABS) blend containing proprietary fillers. Added features of this grade include: Permanently Anti-Static, Flame Retardant.

GENERAL INFORMATION	
Features	Flame Retardant, Antistatic
Fillers	Unreinforced
Polymer Types	Polycarbonate + ABS (PC+ABS)
Processing Techniques	Injection Molding

  

INDUSTRY	SUB INDUSTRY
Electrical and Electronics	Electronic Components
Industrial	Material Handling

## TYPICAL PROPERTY VALUES

Revision 20250303

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
<b>MECHANICAL <sup>(1)</sup></b>			
Tensile Stress, yield	55	MPa	ASTM D638
Tensile Stress, break	49	MPa	ASTM D638
Tensile Strain, yield	5	%	ASTM D638
Tensile Strain, break	100	%	ASTM D638
Tensile Modulus, 50 mm/min	2150	MPa	ASTM D638
Flexural Stress	84	MPa	ASTM D790
Flexural Modulus	2150	MPa	ASTM D790
<b>IMPACT <sup>(1)</sup></b>			
Izod Impact, notched, 23°C	640	J/m	ASTM D256
Instrumented Dart Impact Energy @ peak, 23°C	38	J	ASTM D3763
<b>THERMAL <sup>(1)</sup></b>			
HDT, 1.82 MPa, 3.2mm, unannealed	100	°C	ASTM D648
Relative Temp Index, Elec <sup>(2)</sup>	60	°C	UL 746B
Relative Temp Index, Mech w/impact <sup>(2)</sup>	60	°C	UL 746B
Relative Temp Index, Mech w/o impact <sup>(2)</sup>	60	°C	UL 746B
<b>PHYSICAL <sup>(1)</sup></b>			
Density	1.26	g/cm <sup>3</sup>	ASTM D792
Mold Shrinkage, flow, 24 hrs <sup>(3)</sup>	0.53 – 0.65	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs <sup>(3)</sup>	0.53 – 0.65	%	ASTM D955
<b>ELECTRICAL <sup>(1)</sup></b>			

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Surface Resistivity <sup>(4)</sup>	1.E+10 – 1.E+12	Ω	ASTM D257
FLAME CHARACTERISTICS <sup>(2)</sup>			
UL Yellow Card Link	<u>E121562-101344698</u>	-	-
UL Recognized, 94V-0 Flame Class Rating	1.5	mm	UL 94
INJECTION MOLDING <sup>(5)</sup>			
Drying Temperature	80	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	230 – 250	°C	
Nozzle Temperature	230 – 250	°C	
Front - Zone 3 Temperature	230 – 250	°C	
Middle - Zone 2 Temperature	220 – 245	°C	
Rear - Zone 1 Temperature	210 – 230	°C	
Mold Temperature	60 – 90	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (4) Measurement meets requirements as specified in ASTM D4496.
- (5) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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